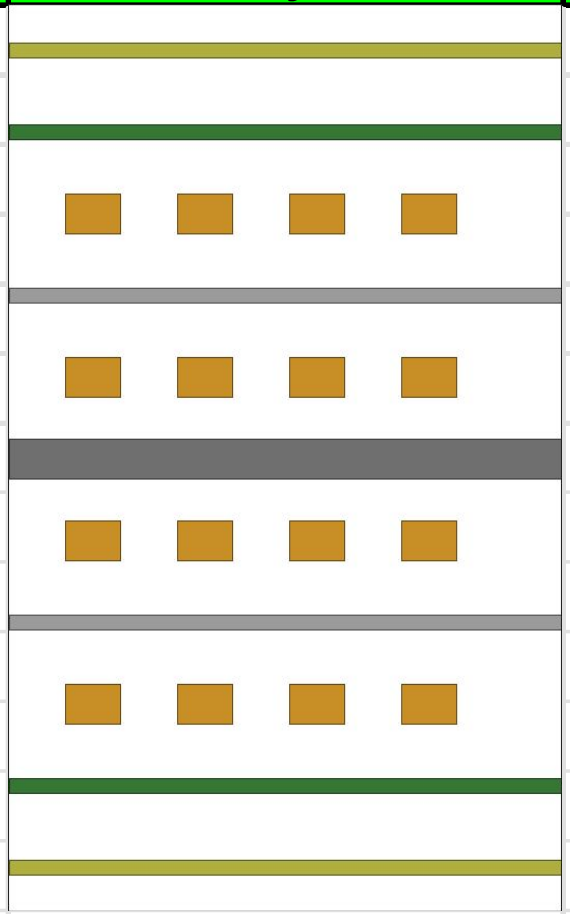
Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Top Layer	Copper	0.070mm	
5		Dielectric 1	FR4	0.150mm	4.2
6		Mid-Layer 1	Copper	0.070mm	
7		Dielectric 3	FR4	1.000mm	4.2
8		Mid-Layer 2	Copper	0.070mm	
9		Dielectric 2	FR4	0.150mm	4.2
10		Bottom Layer	Copper	0.070mm	
11		Bottom Solder	Solder Resist	0.010mm	3.5
12		Bottom Overlay			
13		Bottom Paste			
	Height : 1.600mm				